

ABSTRACT

METHOD AND APPARATUS FOR PROCESSING

AN ARRAY OF COMPONENTS

5 The invention provides a method and apparatus for processing an array of electronic components. It involves providing mounting means to mount unsingulated components onto the mounting means, singulating the components  
10 to physically separate them, and testing the singulated electronic components for defects whilst they are mounted on the mounting means, and without removal therefrom.

(Figure 4)

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